





3A SBR SUPER BARRIER RECTIFIER

Features

V _{RRM} (V)	I _O (A)	V _{F MAX} (V)	I _{R MAX} (μ A)
150	3	0.91	10

Features

- Ultra-Low Forward Voltage Drop
- Superior Reverse Avalanche Capability
- Patented Super Barrier Rectifier SBR® Technology
- Soft, Fast Switching Capability
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Description and Applications

The SBR3U150LP is a single rectifier in the low-profile U-DFN3030-8 package. Offering excellent high-temperature stability and low forward voltage, this device is ideal for use in general rectification applications such as:

- Boost Diode
- Blocking Diode
- Recirculating Diode

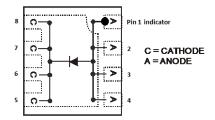
Mechanical Data

- Case: U-DFN3030-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—NiPdAu Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 @
- Weight: 0.0172 grams (Approximate)

U-DFN3030-8



Bottom View



Top View Schematic and Pin Configuration

Ordering Information (Note 4)

Part Number	Case	Packaging
SBR3U150LP-7	U-DFN3030-8	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3.Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, see http://www.diodes.com/products/packages.html.

Marking Information



SVB = Product Marking Code YYWW = Date Code Marking YY = Last Two Digits of Year (ex: 18 for 2018) WW = Week Code (01 to 53)



Maximum Ratings (@TA = +25°C, unless otherwise specified.)

Single-phase, half-wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage	V _{RRM} V _{RWM}	150	V
DC Blocking Voltage	VRM	100	•
RMS Reverse Voltage	V _{R(RMS)}	106	V
Average Rectified Output Current	Io	3.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	33	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Thermal Resistance Junction to Ambient (Note 5) @ T _A = +25°C	R _{OJA}	60	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

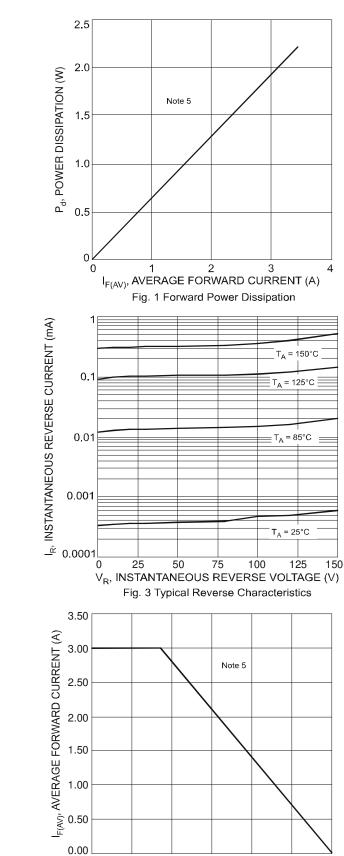
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

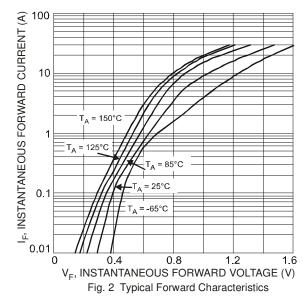
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	150	_	_	V	$I_R = 2mA$
Forward Voltage	V _F	_	_	0.91	V	I _F = 3.0A, T _J = +25°C
Leakage Current (Note 6)	I _R	_	_	10	μΑ	$V_R = 150V, T_J = +25$ °C

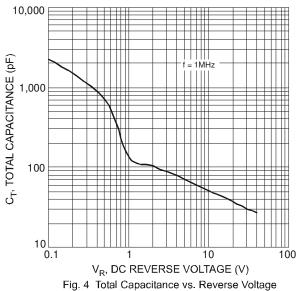
Notes:

- 5. Device mounted on 2oz. Copper, 75mm² pad area, double-side PCB.
 6. Short duration pulse test used to minimize self-heating effect.









TA, DERATED AMBIENT TEMPERATURE (°C) 90 105 120 135 150 V_R, DC REVERSE VOLTAGE (V) Fig. 6 Operating Temperature Derating

T_A, AMBIENT TEMPERATURE (°C)

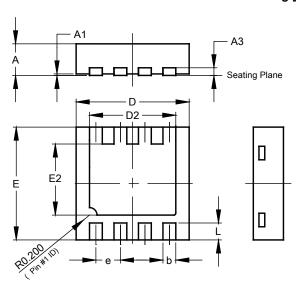
Fig. 5 Forward Current Derating Curve



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN3030-8

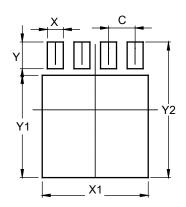


U-DFN3030-8					
Dim	Min	Max	Тур		
Α	0.57	0.63	0.60		
A1	0	0.05	0.02		
A3	-	-	0.15		
b	0.29	0.39	0.34		
D	2.90	3.10	3.00		
D2	2.19	2.39	2.29		
е	-	-	0.65		
Е	2.90	3.10	3.00		
E2	1.64	1.84	1.74		
L	0.30	0.60	0.45		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN3030-8



Dimonoiono	Value	
Dimensions	(in mm)	
С	0.650	
X	0.390	
X1	2.590	
Υ	0.650	
Y1	2.490	
Y2	3.300	



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